



Welcome to [E-XFL.COM](#)

Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

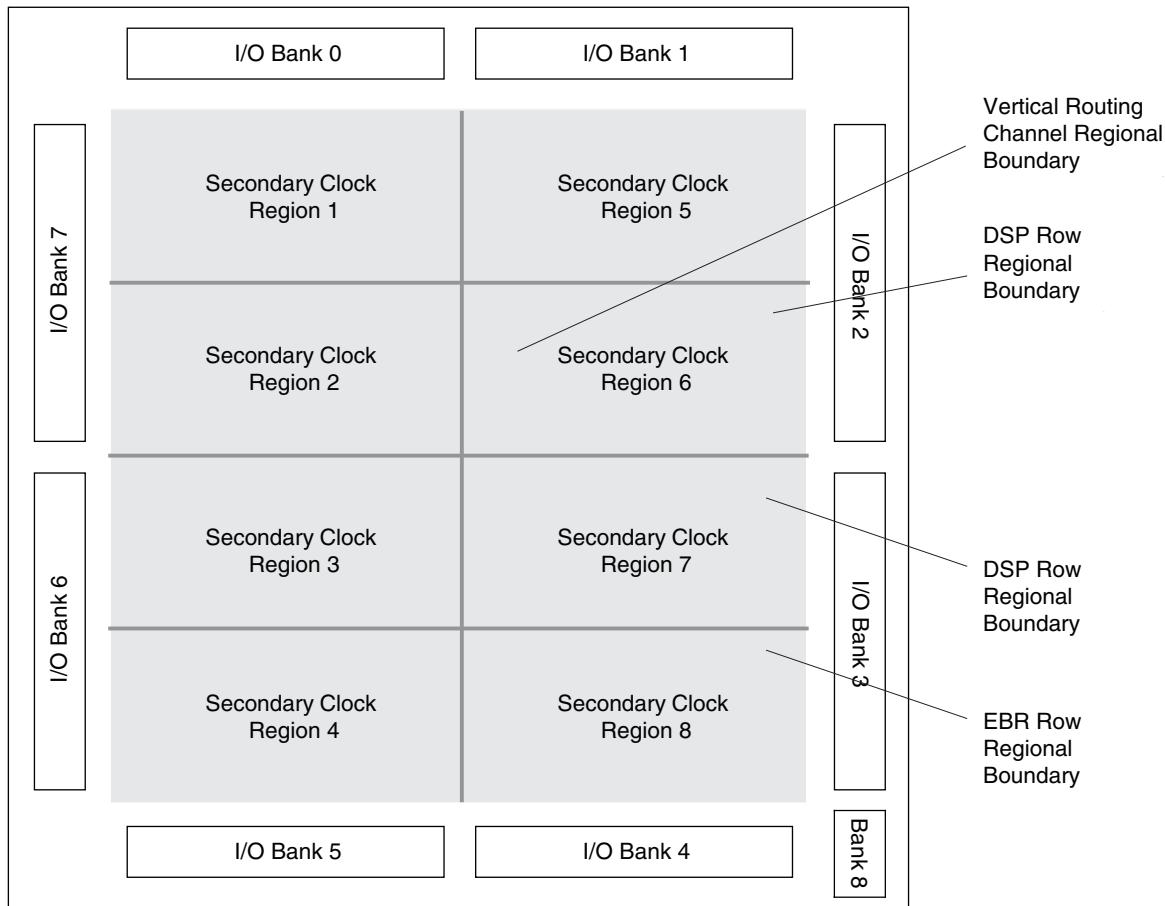
Details

Product Status	Obsolete
Number of LABs/CLBs	6000
Number of Logic Elements/Cells	48000
Total RAM Bits	4246528
Number of I/O	372
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m50e-7f672c

this special vertical routing channel and the eight secondary clock regions for the ECP2-50. LatticeECP2 devices have four secondary clocks (SC0 to SC3) which are distributed to every region.

The secondary clock muxes are located in the center of the device. Figure 2-16 shows the mux structure of the secondary clock routing. Secondary clocks SC0 to SC3 are used for clock and control and SC4 to SC7 are used for high fan-out signals.

Figure 2-15. Secondary Clock Regions ECP2-50



DQSXFER

LatticeECP2/M devices provide a DQSXFER signal to the output buffer to assist it in data transfer to DDR memories that require DQS strobe be shifted 90°. This shifted DQS strobe is generated by the DQSDEL block. The DQSXFER signal runs the span of the data bus.

sysI/O Buffer

Each I/O is associated with a flexible buffer referred to as a sysI/O buffer. These buffers are arranged around the periphery of the device in groups referred to as banks. The sysI/O buffers allow users to implement the wide variety of standards that are found in today's systems including LVCMOS, SSTL, HSTL, LVDS and LVPECL.

sysI/O Buffer Banks

LatticeECP2/M devices have nine sysI/O buffer banks: eight banks for user I/Os arranged two per side. The ninth sysI/O buffer bank (Bank 8) is located adjacent to Bank 3 and has dedicated/shared I/Os for configuration. When a shared pin is not used for configuration it is available as a user I/O. Each bank is capable of supporting multiple I/O standards. Each sysI/O bank has its own I/O supply voltage (V_{CCIO}). In addition, each bank, except Bank 8, has voltage references, V_{REF1} and V_{REF2} , which allow it to be completely independent from the others. Bank 8 shares two voltage references, V_{REF1} and V_{REF2} , with Bank 3. Figure 2-37 shows the nine banks and their associated supplies.

In LatticeECP2/M devices, single-ended output buffers and ratioed input buffers (LVTTL, LVCMOS and PCI) are powered using V_{CCIO} . LVTTL, LVCMOS33, LVCMOS25 and LVCMOS12 can also be set as fixed threshold inputs independent of V_{CCIO} .

Each bank can support up to two separate V_{REF} voltages, V_{REF1} and V_{REF2} , that set the threshold for the referenced input buffers. Some dedicated I/O pins in a bank can be configured to be a reference voltage supply pin. Each I/O is individually configurable based on the bank's supply and reference voltages.

sysI/O Single-Ended DC Electrical Characteristics

Input/Output Standard	V _{IL}		V _{IH}		V _{OL} Max. (V)	V _{OH} Min. (V)	I _{OL} ¹ (mA)	I _{OH} ¹ (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	3.6	0.4	V _{CCIO} - 0.4	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	V _{CCIO} - 0.2	0.1	-0.1
LVTTL	-0.3	0.8	2.0	3.6	0.4	V _{CCIO} - 0.4	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	V _{CCIO} - 0.2	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	V _{CCIO} - 0.4	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	V _{CCIO} - 0.2	0.1	-0.1
LVCMOS 1.8	-0.3	0.35 V _{CCIO}	0.65 V _{CCIO}	3.6	0.4	V _{CCIO} - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	V _{CCIO} - 0.2	0.1	-0.1
LVCMOS 1.5	-0.3	0.35 V _{CCIO}	0.65 V _{CCIO}	3.6	0.4	V _{CCIO} - 0.4	8, 4	-8, -4
					0.2	V _{CCIO} - 0.2	0.1	-0.1
LVCMOS 1.2	-0.3	0.35 V _{CC}	0.65 V _{CC}	3.6	0.4	V _{CCIO} - 0.4	6, 2	-6, -2
					0.2	V _{CCIO} - 0.2	0.1	-0.1
PCI	-0.3	0.3 V _{CCIO}	0.5 V _{CCIO}	3.6	0.1 V _{CCIO}	0.9 V _{CCIO}	1.5	-0.5
SSTL3 Class I	-0.3	V _{REF} - 0.2	V _{REF} + 0.2	3.6	0.7	V _{CCIO} - 1.1	8	-8
SSTL3 Class II	-0.3	V _{REF} - 0.2	V _{REF} + 0.2	3.6	0.5	V _{CCIO} - 0.9	16	-16
SSTL2 Class I	-0.3	V _{REF} - 0.18	V _{REF} + 0.18	3.6	0.54	V _{CCIO} - 0.62	7.6	-7.6
							12	-12
SSTL2 Class II	-0.3	V _{REF} - 0.18	V _{REF} + 0.18	3.6	0.35	V _{CCIO} - 0.43	15.2	-15.2
							20	-20
SSTL18 Class I	-0.3	V _{REF} - 0.125	V _{REF} + 0.125	3.6	0.4	V _{CCIO} - 0.4	6.7	-6.7
SSTL18 Class II	-0.3	V _{REF} - 0.125	V _{REF} + 0.125	3.6	0.28	V _{CCIO} - 0.28	8	-8
							11	-11
HSTL Class I	-0.3	V _{REF} - 0.1	V _{REF} + 0.1	3.6	0.4	V _{CCIO} - 0.4	4	-4
							8	-8
HSTL18 Class I	-0.3	V _{REF} - 0.1	V _{REF} + 0.1	3.6	0.4	V _{CCIO} - 0.4	8	-8
							12	-12
HSTL18 Class II	-0.3	V _{REF} - 0.1	V _{REF} + 0.1	3.6	0.4	V _{CCIO} - 0.4	16	-16

1. The average DC current drawn by I/Os between GND connections, or between the last GND in an I/O bank and the end of an I/O bank, as shown in the logic signal connections table shall not exceed n * 8mA, where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

LatticeECP2/M Internal Switching Characteristics¹

Over Recommended Operating Conditions

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
PFU/PFF Logic Mode Timing								
t _{LUT4_PFU}	LUT4 delay (A to D inputs to F output)	—	0.180	—	0.198	—	0.216	ns
t _{LUT6_PFU}	LUT6 delay (A to D inputs to OFX output)	—	0.304	—	0.331	—	0.358	ns
t _{LSR_PFU}	Set/Reset to output of PFU (Asynchronous)	—	0.600	—	0.655	—	0.711	ns
t _{SUM_PFU}	Clock to Mux (M0,M1) Input Setup Time	0.128	—	0.129	—	0.129	—	ns
t _{HM_PFU}	Clock to Mux (M0,M1) Input Hold Time	-0.051	—	-0.049	—	-0.046	—	ns
t _{SUD_PFU}	Clock to D input setup time	0.061	—	0.071	—	0.081	—	ns
t _{HD_PFU}	Clock to D input hold time	0.002	—	0.003	—	0.003	—	ns
t _{CK2Q_PFU}	Clock to Q delay, (D-type Register Configuration)	—	0.285	—	0.309	—	0.333	ns
PFU Dual Port Memory Mode Timing								
t _{CORAM_PFU}	Clock to Output (F Port)	—	0.902	—	1.083	—	1.263	ns
t _{SUDATA_PFU}	Data Setup Time	-0.172	—	-0.205	—	-0.238	—	ns
t _{HDATA_PFU}	Data Hold Time	0.199	—	0.235	—	0.271	—	ns
t _{SUADDR_PFU}	Address Setup Time	-0.245	—	-0.284	—	-0.323	—	ns
t _{HADDR_PFU}	Address Hold Time	0.246	—	0.285	—	0.324	—	ns
t _{SUWREN_PFU}	Write/Read Enable Setup Time	-0.122	—	-0.145	—	-0.168	—	ns
t _{HWREN_PFU}	Write/Read Enable Hold Time	0.132	—	0.156	—	0.180	—	ns
PIC Timing								
PIO Input/Output Buffer Timing								
t _{IN_PIO}	Input Buffer Delay (LVCMOS25)	—	0.613	—	0.681	—	0.749	ns
t _{OUT_PIO}	Output Buffer Delay (LVCMOS25)	—	1.115	—	1.115	—	1.343	ns
IOLOGIC Input/Output Timing								
t _{SUI_PIO}	Input Register Setup Time (Data Before Clock)	0.596	—	0.645	—	0.694	—	ns
t _{HI_PIO}	Input Register Hold Time (Data after Clock)	-0.570	—	-0.614	—	-0.658	—	ns
t _{COO_PIO}	Output Register Clock to Output Delay	—	0.61	—	0.66	—	0.72	ns
t _{SUCE_PIO}	Input Register Clock Enable Setup Time	0.032	—	0.037	—	0.041	—	ns
t _{HCE_PIO}	Input Register Clock Enable Hold Time	-0.022	—	-0.025	—	-0.028	—	ns
t _{SULSR_PIO}	Set/Reset Setup Time	0.184	—	0.201	—	0.217	—	ns
t _{HLSR_PIO}	Set/Reset Hold Time	-0.080	—	-0.086	—	-0.093	—	ns
EBR Timing								
t _{CO_EBR}	Clock (Read) to output from Address or Data	—	2.51	—	2.75	—	2.99	ns
t _{COO_EBR}	Clock (Write) to output from EBR output Register	—	0.33	—	0.36	—	0.39	ns
t _{SUDATA_EBR}	Setup Data to EBR Memory	-0.157	—	-0.181	—	-0.205	—	ns
t _{HDATA_EBR}	Hold Data to EBR Memory	0.173	—	0.195	—	0.217	—	ns
t _{SUADDR_EBR}	Setup Address to EBR Memory	-0.115	—	-0.130	—	-0.145	—	ns
t _{HADDR_EBR}	Hold Address to EBR Memory	0.138	—	0.155	—	0.172	—	ns
t _{SUWREN_EBR}	Setup Write/Read Enable to PFU Memory	-0.128	—	-0.149	—	-0.170	—	ns

SERDES High-Speed Data Transmitter (LatticeECP2M Family Only)^{1,2}

Table 3-7. Serial Output Timing and Levels

Symbol	Description	Frequency	Min.	Typ.	Max.	Units
V _{TX-DIFF-P-P-1}	Differential swing (1V setting) ^{1,2}	0.25 to 3.125 Gbps	0.79	0.99	1.19	V, p-p
V _{TX-DIFF-P-P-1.25}	Differential swing (1.25V setting) ^{1,2}	0.25 to 3.125 Gbps	1.00	1.25	1.50	V, p-p
V _{TX-DIFF-P-P-1.3}	Differential swing (1.3V setting) ^{1,2}	0.25 to 3.125 Gbps	1.04	1.30	1.56	V, p-p
V _{TX-DIFF-P-P-1.35}	Differential swing (1.35V setting) ^{1,2}	0.25 to 3.125 Gbps	1.08	1.35	1.62	V, p-p
V _{OCM}	Output common mode voltage	—	V _{CCOB} - 0.75	V _{CCOB} - 0.60	V _{CCOB} - 0.45	V
T _{TX-R}	Rise time (20% to 80%)	—	—	70	—	ps
T _{TX-F}	Fall time (80% to 20%)	—	—	70	—	ps
Z _{TX-OI-SE}	Output impedance 50/75/HiZ K Ohms (single-ended)	—	—	50/70 HiZ	—	Ohms
R _{TX-RL}	Return loss (with package)	—	—	9	—	dB

1. All measurements are with 50 ohm impedance.

2. See TN1124, [LatticeECP2M SERDES/PCS Usage Guide](#) for actual binary settings.

Table 3-8. Channel Output Jitter - x10 Mode

Description	Frequency	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	—	0.08	0.12	UI, p-p
Random	3.125 Gbps	—	0.22	0.38	UI, p-p
Total	3.125 Gbps	—	0.33	0.43	UI, p-p
Deterministic	2.5 Gbps	—	0.08	0.17	UI, p-p
Random	2.5 Gbps	—	0.20	0.25	UI, p-p
Total	2.5 Gbps	—	0.25	0.35	UI, p-p
Deterministic	1.25 Gbps	—	0.03	0.10	UI, p-p
Random	1.25 Gbps	—	0.14	0.19	UI, p-p
Total	1.25 Gbps	—	0.17	0.24	UI, p-p
Deterministic	250 Mbps	—	0.04	0.17	UI, p-p
Random	250 Mbps	—	0.12	0.13	UI, p-p
Total	250 Mbps	—	0.15	0.29	UI, p-p

Note: Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, reference clock at x10 mode.

Available Device Resources by Package, LatticeECP2

Resource	Device	256 fpBGA	484 fpBGA	672 fpBGA	900 fpBGA
PLL/DLL	ECP2-6	4	—	—	—
	ECP2-12	4	4	—	—
	ECP2-20	4	4	4	—
	ECP2-35	—	4	4	—
	ECP2-50	—	6	6	—
	ECP2-70	—	—	8	8

Available Device Resources by Package, LatticeECP2M

Resource	Device	256 fpBGA	484 fpBGA	672 fpBGA	900 fpBGA	1152 fpBGA
PLL/DLL	ECP2M20	10	10	—	—	—
	ECP2M35	10	10	10	—	—
	ECP2M50	—	10	10	10	—
	ECP2M70	—	—	—	10	10
	ECP2M100	—	—	—	10	10

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
1	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*
2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*
3	PL4A	7		T (LVDS)*	PL4A	7		T (LVDS)*
4	PL4B	7		C (LVDS)*	PL4B	7		C (LVDS)*
5	PL6A	7	LDQ10	T (LVDS)*	PL6A	7	LDQ10	T (LVDS)*
6	VCCAUX	-			VCCAUX	-		
7	PL6B	7	LDQ10	C (LVDS)*	PL6B	7	LDQ10	C (LVDS)*
8	PL8A	7	LDQ10	T (LVDS)*	PL8A	7	LDQ10	T (LVDS)*
9	VCCIO7	7			VCCIO7	7		
10	PL8B	7	LDQ10	C (LVDS)*	PL8B	7	LDQ10	C (LVDS)*
11	GND	-			GND	-		
12	PL12A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ10	T (LVDS)*
13	PL12B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ10	C (LVDS)*
14	PL13A	7	PCLKT7_0/LDQ10	T	PL13A	7	PCLKT7_0/LDQ10	T
15	PL13B	7	PCLKC7_0/LDQ10	C	PL13B	7	PCLKC7_0/LDQ10	C
16	VCC	-			VCC	-		
17	PL15A	6	PCLKT6_0	T (LVDS)*	PL15A	6	PCLKT6_0	T (LVDS)*
18	PL15B	6	PCLKC6_0	C (LVDS)*	PL15B	6	PCLKC6_0	C (LVDS)*
19	PL16A	6	VREF2_6	T	PL16A	6	VREF2_6	T
20	PL16B	6	VREF1_6	C	PL16B	6	VREF1_6	C
21	GND	-			GND	-		
22	VCC	-			VCC	-		
23	PL18A	6	LLM0_GDLLT_FB_A	T	PL18A	6	LLM0_GDLLT_FB_A	T
24	PL18B	6	LLM0_GDLLC_FB_A	C	PL18B	6	LLM0_GDLLC_FB_A	C
25	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
26	PL20A	6	LLM0_GPLL_IN_A**	T (LVDS)*	PL20A	6	LLM0_GPLL_IN_A**	T (LVDS)*
27	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*
28	PL22A	6			PL22A	6		
29	VCC	-			VCC	-		
30	GND	-			GND	-		
31	VCCIO6	6			VCCIO6	6		
32	TCK	-			TCK	-		
33	TDI	-			TDI	-		
34	TDO	-			TDO	-		
35	VCCJ	-			VCCJ	-		
36	TMS	-			TMS	-		
37	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
38	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
39	VCCAUX	-			VCCAUX	-		
40	PB4A	5	BDQ6	T	PB6A	5	BDQS6	T
41	PB4B	5	BDQ6	C	PB6B	5	BDQ6	C
42	VCCIO5	5			VCCIO5	5		
43	PB6A	5	BDQS6	T	PB12A	5	BDQ15	T
44	PB6B	5	BDQ6	C	PB12B	5	BDQ15	C
45	NC	5			PB16A	5	BDQ15	T

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
184	GND	-			GND	-		
185	PT28A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T
186	PT26B	0		C	PT36B	0		C
187	PT26A	0		T	PT36A	0		T
188	VCC	-			VCC	-		
189	PT20B	0		C	PT30B	0		C
190	VCCAUX	-			VCCAUX	-		
191	PT20A	0		T	PT30A	0		T
192	GND	-			GND	-		
193	PT18B	0		C	PT26B	0		C
194	PT18A	0		T	PT26A	0		T
195	VCCIO0	0			VCCIO0	0		
196	PT16B	0		C	PT20B	0		C
197	PT16A	0		T	PT20A	0		T
198	VCC	-			VCC	-		
199	PT12B	0		C	PT12B	0		C
200	PT12A	0		T	PT12A	0		T
201	GND	-			GND	-		
202	PT8B	0		C	PT8B	0		C
203	PT8A	0		T	PT8A	0		T
204	PT6B	0		C	PT6B	0		C
205	PT6A	0		T	PT6A	0		T
206	VCCIO0	0			VCCIO0	0		
207	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
208	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for PLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
M6	PL15B	6	PCLKC6_0	C (LVDS)*	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*
M3	PL16A	6	VREF2_6	T	PL22A	6	VREF2_6/LDQ25	T
GNDIO	GNDIO6	-			-	-		
M4	PL16B	6	VREF1_6	C	PL22B	6	VREF1_6/LDQ25	C
-	-	-			VCCIO6	6		
N1	NC	-			PL24A	6	LDQ25	T
M2	NC	-			PL23A	6	LDQ25	T (LVDS)*
N2	NC	-			PL24B	6	LDQ25	C
M1	NC	-			PL23B	6	LDQ25	C (LVDS)*
-	-	-			GNDIO	-		
N3	NC	-			PL25A	6	LDQS25	T (LVDS)*
N5	NC	-			PL26A	6	LDQ25	T
N4	NC	-			PL25B	6	LDQ25	C (LVDS)*
-	-	-			VCCIO6	6		
P5	NC	-			PL26B	6	LDQ25	C
P1	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*
P2	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*
P4	PL18A	6	LLM0_GDLLT_FB_A	T	PL28A	6	LLM0_GDLLT_FB_A/LDQ25	T
-	-	-			GNDIO	-		
R4	PL18B	6	LLM0_GDLLC_FB_A	C	PL28B	6	LLM0_GDLLC_FB_A/LDQ25	C
P6	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
R1	PL20A	6	LLM0_GPLL_In_A**	T (LVDS)*	PL30A	6	LLM0_GPLL_In_A**/LDQ34	T (LVDS)*
GNDIO	GNDIO6	-			-	-		
R3	PL21A	6	LLM0_GPLL_In_A	T	PL31A	6	LLM0_GPLL_In_A/ LDQ34	T
R2	PL20B	6	LLM0_GPLL_In_A**	C (LVDS)*	PL30B	6	LLM0_GPLL_In_A/ LDQ34	C (LVDS)*
T4	PL21B	6	LLM0_GPLL_In_A	C	PL31B	6	LLM0_GPLL_In_A/ LDQ34	C
T5	PL23A	6		T	PL33A	6	LDQ34	T
VCCIO	VCCIO6	6			VCCIO6	6		
T1	PL22A	6		T (LVDS)*	PL32A	6	LDQ34	T (LVDS)*
T3	PL23B	6		C	PL33B	6	LDQ34	C
T2	PL22B	6		C (LVDS)*	PL32B	6	LDQ34	C (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
-	-	-			VCCIO6	6		
V1	PL25A	6	LDQ28	T	PL39A	6	LDQ42	T
-	-	-			GNDIO	-		
V2	PL25B	6	LDQ28	C	PL39B	6	LDQ42	C
U1	PL24A	6	LDQ28	T (LVDS)*	PL38A	6	LDQ42	T (LVDS)*
U3	PL27A	6	LDQ28	T	PL41A	6	LDQ42	T
VCCIO	VCCIO6	6			VCCIO6	6		
U2	PL24B	6	LDQ28	C (LVDS)*	PL38B	6	LDQ42	C (LVDS)*
U4	PL27B	6	LDQ28	C	PL41B	6	LDQ42	C
R6	PL26A	6	LDQ28	T (LVDS)*	PL40A	6	LDQ42	T (LVDS)*
R7	PL29A	6	LDQ28	T	PL43A	6	LDQ42	T
GNDIO	GNDIO6	-			GNDIO	-		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AE17	PB60B	4	BDQ60	C	PB69B	4	BDQ69	C	
AB19	PB61A	4	BDQ60	T	PB70A	4	BDQ69	T	
AE19	PB61B	4	BDQ60	C	PB70B	4	BDQ69	C	
AF17	PB62A	4	BDQ60	T	PB71A	4	BDQ69	T	
AE18	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
W16	PB63A	4	BDQ60	T	PB72A	4	BDQ69	T	
AA17	PB63B	4	BDQ60	C	PB72B	4	BDQ69	C	
AF18	PB64A	4	BDQ60	T	PB73A	4	BDQ69	T	
AF19	PB64B	4	BDQ60	C	PB73B	4	BDQ69	C	
GND	GNDIO4	-			GNDIO4	-			
AA19	PB65A	4	BDQ69	T	PB74A	4	BDQ78	T	
W17	PB65B	4	BDQ69	C	PB74B	4	BDQ78	C	
Y19	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T	
Y17	PB66B	4	BDQ69	C	PB75B	4	BDQ78	C	
AF20	PB67A	4	BDQ69	T	PB76A	4	BDQ78	T	
VCCIO	VCCIO4	4			VCCIO4	4			
AE20	PB67B	4	BDQ69	C	PB76B	4	BDQ78	C	
AA20	PB68A	4	BDQ69	T	PB77A	4	BDQ78	T	
W18	PB68B	4	BDQ69	C	PB77B	4	BDQ78	C	
AD20	PB69A	4	BDQS69	T	PB78A	4	BDQS78	T	
GND	GNDIO4	-			GNDIO4	-			
AE21	PB69B	4	BDQ69	C	PB78B	4	BDQ78	C	
AF21	PB70A	4	BDQ69	T	PB79A	4	BDQ78	T	
AF22	PB70B	4	BDQ69	C	PB79B	4	BDQ78	C	
VCCIO	VCCIO4	4			VCCIO4	4			
GND	GNDIO4	-			GNDIO4	-			
AE22	PB74A	4	BDQ78	T	PB92A	4	BDQ96	T	
AD22	PB74B	4	BDQ78	C	PB92B	4	BDQ96	C	
AF23	PB75A	4	BDQ78	T	PB93A	4	BDQ96	T	
AE23	PB75B	4	BDQ78	C	PB93B	4	BDQ96	C	
AD23	PB76A	4	BDQ78	T	PB94A	4	BDQ96	T	
AC23	PB76B	4	BDQ78	C	PB94B	4	BDQ96	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AB20	PB77A	4	BDQ78	T	PB95A	4	BDQ96	T	
AC20	PB77B	4	BDQ78	C	PB95B	4	BDQ96	C	
GND	GNDIO4	-			GNDIO4	-			
AB21	PB78A	4	BDQS78	T	PB96A	4	BDQS96	T	
AC22	PB78B	4	BDQ78	C	PB96B	4	BDQ96	C	
W19	PB79A	4	BDQ78	T	PB97A	4	BDQ96	T	
AA21	PB79B	4	BDQ78	C	PB97B	4	BDQ96	C	
AF24	PB80A	4	BDQ78	T	PB98A	4	BDQ96	T	
AE24	PB80B	4	BDQ78	C	PB98B	4	BDQ96	C	
VCCIO	VCCIO4	4			VCCIO4	4			
Y20	PB81A	4	BDQ78	T	PB99A	4	BDQ96	T	
AB22	PB81B	4	BDQ78	C	PB99B	4	BDQ96	C	

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GND	GNDIO2	-			GNDIO2	-			
L21	PR43B	2	RDQ41	C (LVDS)*	PR56B	2	RDQ54	C (LVDS)*	
K22	PR43A	2	RDQ41	T (LVDS)*	PR56A	2	RDQ54	T (LVDS)*	
M24	PR42B	2	RDQ41	C	PR55B	2	RDQ54	C	
N23	PR42A	2	RDQ41	T	PR55A	2	RDQ54	T	
VCCIO	VCCIO2	2			VCCIO2	2			
K26	PR41B	2	RDQ41	C (LVDS)*	PR54B	2	RDQ54	C (LVDS)*	
K25	PR41A	2	RDQS41	T (LVDS)*	PR54A	2	RDQS54	T (LVDS)*	
M20	PR40B	2	RDQ41	C	PR53B	2	RDQ54	C	
GND	GNDIO2	-			GNDIO2	-			
M19	PR40A	2	RDQ41	T	PR53A	2	RDQ54	T	
L22	PR39B	2	RDQ41	C (LVDS)*	PR52B	2	RDQ54	C (LVDS)*	
M22	PR39A	2	RDQ41	T (LVDS)*	PR52A	2	RDQ54	T (LVDS)*	
K21	PR38B	2	RDQ41	C	PR51B	2	RDQ54	C	
VCCIO	VCCIO2	2			VCCIO2	2			
M21	PR38A	2	RDQ41	T	PR51A	2	RDQ54	T	
K24	PR37B	2	RDQ41	C (LVDS)*	PR50B	2	RDQ54	C (LVDS)*	
J24	PR37A	2	RDQ41	T (LVDS)*	PR50A	2	RDQ54	T (LVDS)*	
GND	GNDIO2	-			GNDIO2	-			
VCCIO	VCCIO2	2			VCCIO2	2			
L20	VCCPLL	2			NC	-			
GND	GNDIO2	-			GNDIO2	-			
J26	PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C	
J25	PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T	
J23	PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C	
K23	PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T	
VCCIO	VCCIO2	2			VCCIO2	2			
H26	PR24B	2	RDQ24	C (LVDS)*	PR37B	2	RDQ37	C (LVDS)*	
H25	PR24A	2	RDQS24***	T (LVDS)*	PR37A	2	RDQS37***	T (LVDS)*	
H24	PR23B	2	RDQ24	C	PR36B	2	RDQ37	C	
GND	GNDIO2	-			GNDIO2	-			
H23	PR23A	2	RDQ24	T	PR36A	2	RDQ37	T	
VCCIO	VCCIO2	2			VCCIO2	2			
G26	PR19B	2	RDQ16	C	PR32B	2	RDQ29	C	
GND	GNDIO2	-			GNDIO2	-			
G25	PR19A	2	RDQ16	T	PR32A	2	RDQ29	T	
F26	PR18B	2	RDQ16	C (LVDS)*	PR31B	2	RDQ29	C (LVDS)*	
F25	PR18A	2	RDQ16	T (LVDS)*	PR31A	2	RDQ29	T (LVDS)*	
K20	PR17B	2	RDQ16	C	PR30B	2	RDQ29	C	
VCCIO	VCCIO2	2			VCCIO2	2			
L19	PR17A	2	RDQ16	T	PR30A	2	RDQ29	T	
E26	PR16B	2	RDQ16	C (LVDS)*	PR29B	2	RDQ29	C (LVDS)*	
E25	PR16A	2	RDQS16	T (LVDS)*	PR29A	2	RDQS29	T (LVDS)*	
GND	GNDIO2	-			GNDIO2	-			
J22	PR15B	2	RDQ16	C	PR28B	2	RDQ29	C	
H22	PR15A	2	RDQ16	T	PR28A	2	RDQ29	T	

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C5	PT11B	0		C
D5	PT11A	0		T
E9	PT10B	0		C
G9	PT10A	0		T
GND	GNDIO0	-		
B10	PT9B	0		C
A10	PT9A	0		T
D9	PT8B	0		C
C9	PT8A	0		T
VCCIO	VCCIO0	0		
F9	PT7B	0		C
H9	PT7A	0		T
B9	PT6B	0		C
A9	PT6A	0		T
GND	GNDIO0	-		
E8	PT5B	0		C
G8	PT5A	0		T
A8	PT4B	0		C
B8	PT4A	0		T
VCCIO	VCCIO0	0		
F8	PT3B	0		C
F7	PT3A	0		T
J10	PT2B	0	VREF2_0	C
J9	PT2A	0	VREF1_0	T
AA11	VCC	-		
AA20	VCC	-		
K11	VCC	-		
K21	VCC	-		
K22	VCC	-		
L11	VCC	-		
L12	VCC	-		
L13	VCC	-		
L18	VCC	-		
L19	VCC	-		
L20	VCC	-		
M11	VCC	-		
M20	VCC	-		
N11	VCC	-		
N20	VCC	-		
V11	VCC	-		
V20	VCC	-		
W11	VCC	-		
W20	VCC	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C13	GND	-		
C18	GND	-		
C23	GND	-		
C28	GND	-		
C3	GND	-		
C8	GND	-		
H28	GND	-		
H3	GND	-		
L14	GND	-		
L15	GND	-		
L16	GND	-		
L17	GND	-		
M12	GND	-		
M13	GND	-		
M14	GND	-		
M15	GND	-		
M16	GND	-		
M17	GND	-		
M18	GND	-		
M19	GND	-		
N12	GND	-		
N13	GND	-		
N14	GND	-		
N15	GND	-		
N16	GND	-		
N17	GND	-		
N18	GND	-		
N19	GND	-		
N28	GND	-		
N3	GND	-		
P11	GND	-		
P12	GND	-		
P13	GND	-		
P14	GND	-		
P15	GND	-		
P16	GND	-		
P17	GND	-		
P18	GND	-		
P19	GND	-		
P20	GND	-		
R11	GND	-		
R12	GND	-		
R13	GND	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
N11	CCLK	8			CCLK	8			
M11	INITN	8			INITN	8			
N13	DONE	8			DONE	8			
GNDIO	GNDIO8	-			GNDIO8	-			
M12	PR53B	8	WRITEN	C	PR68B	8	WRITEN	C	
M13	PR53A	8	CS1N	T	PR68A	8	CS1N	T	
N14	PR52B	8	CSN	C	PR67B	8	CSN	C	
N15	PR52A	8	D0/SPIFASTN	T	PR67A	8	D0/SPIFASTN	T	
VCCIO	VCCIO8	8			VCCIO8	8			
N16	PR51B	8	D1	C	PR66B	8	D1	C	
M16	PR51A	8	D2	T	PR66A	8	D2	T	
L12	PR50B	8	D3	C	PR65B	8	D3	C	
GNDIO	GNDIO8	-			GNDIO8	-			
L13	PR50A	8	D4	T	PR65A	8	D4	T	
L16	PR49B	8	D5	C	PR64B	8	D5	C	
K16	PR49A	8	D6	T	PR64A	8	D6	T	
L14	PR48B	8	D7/SPID0***	C	PR63B	8	D7/SPID0***	C	
VCCIO	VCCIO8	8			VCCIO8	8			
L15	PR48A	8	DI/CSSPI0N	T	PR63A	8	DI/CSSPI0N	T	
K13	PR47B	8	DOUT/CSON/CSSPI1N	C	PR62B	8	DOUT/CSON/CSSPI1N	C	
K14	PR47A	8	BUSY/SISPI	T	PR62A	8	BUSY/SISPI	T	
K11	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
K15	PR45B	3	RLM0_GDLLC_FB_A	C	PR60B	3	RLM0_GDLLC_FB_A/RDQ57	C	
GNDIO	GNDIO3	-			GNDIO3	-			
J16	PR45A	3	RLM0_GDLLT_FB_A	T	PR60A	3	RLM0_GDLLT_FB_A/RDQ57	T	
H16	PR44B	3	RLM0_GDLLC_IN_A	C (LVDS)*	PR59B	3	RLM0_GDLLC_IN_A**/RDQ57	C(LVDS)*	
J15	PR44A	3	RLM0_GDLLT_IN_A	T (LVDS)*	PR59A	3	RLM0_GDLLT_IN_A**/RDQ57	T (LVDS)*	
J14	PR43B	3	RLM0_GPLLIC_IN_A	C	PR58B	3	RLM0_GPLLIC_IN_A**/RDQ57	C	
VCCIO	VCCIO3	3			VCCIO3	3			
J13	PR43A	3	RLM0_GPLLT_IN_A	T	PR58A	3	RLM0_GPLLT_IN_A**/RDQ57	T	
H13	PR42B	3	RLM0_GPLLIC_FB_A	C (LVDS)*	PR57B	3	RLM0_GPLLIC_FB_A/RDQ57	C(LVDS)*	
H12	PR42A	3	RLM0_GPLLT_FB_A	T (LVDS)*	PR57A	3	RLM0_GPLLT_FB_A/RDQS57***	T (LVDS)*	
GNDIO	GNDIO3	-			GNDIO3	-			
VCCIO	VCCIO3	3			VCCIO3	3			
G16	PR32B	3	RLM1_SPLLIC_FB_A	C	PR42B	3	RLM2_SPLLIC_FB_A	C	
VCCIO	VCCIO3	3			VCCIO3	3			
H15	PR32A	3	RLM1_SPLLT_FB_A	T	PR42A	3	RLM2_SPLLT_FB_A	T	
E16	PR31B	3	RLM1_SPLLIC_IN_A	C (LVDS)*	PR41B	3	RLM2_SPLLIC_IN_A	C(LVDS)*	
F15	PR31A	3	RLM1_SPLLT_IN_A	T (LVDS)*	PR41A	3	RLM2_SPLLT_IN_A	T (LVDS)*	
GNDIO	GNDIO3	-			GNDIO3	-			
VCCIO	VCCIO3	3			VCCIO3	3			
F16	PR28B	3	VREF2_3	C	PR38B	3	VREF2_3	C	
G15	PR28A	3	VREF1_3	T	PR38A	3	VREF1_3	T	
J11	PR27B	3	PCLKC3_0	C (LVDS)*	PR37B	3	PCLKC3_0	C(LVDS)*	
J12	PR27A	3	PCLKT3_0	T (LVDS)*	PR37A	3	PCLKT3_0	T (LVDS)*	
G14	PR25B	2	PCLKC2_0/RDQ22	C	PR35B	2	PCLKC2_0/RDQ32	C	
G13	PR25A	2	PCLKT2_0/RDQ22	T	PR35A	2	PCLKT2_0/RDQ32	T	
GNDIO	GNDIO2	-			GNDIO2	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AJ17	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AF26	PB64A	4	BDQ60	T	PB73A	4	BDQ69	T	
AE25	PB64B	4	BDQ60	C	PB73B	4	BDQ69	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AD24	PB65A	4	BDQ69	T	PB74A	4	BDQ78	T	
AE24	PB65B	4	BDQ69	C	PB74B	4	BDQ78	C	
AD18	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T	
AC18	PB66B	4	BDQ69	C	PB75B	4	BDQ78	C	
AE18	PB67A	4	BDQ69	T	PB76A	4	BDQ78	T	
AG19	PB67B	4	BDQ69	C	PB76B	4	BDQ78	C	
VCCIO	VCCIO4	4			VCCIO4	4			
GNDIO	GNDIO4	-			GNDIO4	-			
AC19	PB69A	4	BDQS69	T	PB78A	4	BDQS78	T	
AD20	PB69B	4	BDQ69	C	PB78B	4	BDQ78	C	
AB18	PB70A	4	BDQ69	T	PB79A	4	BDQ78	T	
AC20	PB70B	4	BDQ69	C	PB79B	4	BDQ78	C	
AE20	PB71A	4	BDQ69	T	PB80A	4	BDQ78	T	
AE21	PB71B	4	BDQ69	C	PB80B	4	BDQ78	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AC23	PB72A	4	BDQ69	T	PB81A	4	BDQ78	T	
AD23	PB72B	4	BDQ69	C	PB81B	4	BDQ78	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AH18	LRC_SQ_VCCRX3	13			LRC_SQ_VCCRX3	13			
AK19	LRC_SQ_HDINP3	13		T	LRC_SQ_HDINP3	13			T
AJ18	LRC_SQ_VCCIB3	13			LRC_SQ_VCCIB3	13			
AJ19	LRC_SQ_HDINN3	13		C	LRC_SQ_HDINN3	13			C
AH21	LRC_SQ_VCCTX3	13			LRC_SQ_VCCTX3	13			
AK22	LRC_SQ_HDOUTP3	13		T	LRC_SQ_HDOUTP3	13			T
AK21	LRC_SQ_VCCOB3	13			LRC_SQ_VCCOB3	13			
AJ22	LRC_SQ_HDOUTN3	13		C	LRC_SQ_HDOUTN3	13			C
AH22	LRC_SQ_VCCTX2	13			LRC_SQ_VCCTX2	13			
AJ23	LRC_SQ_HDOUTN2	13		C	LRC_SQ_HDOUTN2	13			C
AH23	LRC_SQ_VCCOB2	13			LRC_SQ_VCCOB2	13			
AK23	LRC_SQ_HDOUTP2	13		T	LRC_SQ_HDOUTP2	13			T
AH19	LRC_SQ_VCCRX2	13			LRC_SQ_VCCRX2	13			
AJ20	LRC_SQ_HDINN2	13		C	LRC_SQ_HDINN2	13			C
AH20	LRC_SQ_VCCIB2	13			LRC_SQ_VCCIB2	13			
AK20	LRC_SQ_HDINP2	13		T	LRC_SQ_HDINP2	13			T
AH24	LRC_SQ_VCCP	13			LRC_SQ_VCCP	13			
AG24	LRC_SQ_REFCLKP	13		T	LRC_SQ_REFCLKP	13			T
AF24	LRC_SQ_REFCLKN	13		C	LRC_SQ_REFCLKN	13			C
AJ24	LRC_SQ_VCCAUX33	13			LRC_SQ_VCCAUX33	13			
AK28	LRC_SQ_HDINP1	13		T	LRC_SQ_HDINP1	13			T
AH28	LRC_SQ_VCCIB1	13			LRC_SQ_VCCIB1	13			
AJ28	LRC_SQ_HDINN1	13		C	LRC_SQ_HDINN1	13			C
AH29	LRC_SQ_VCCRX1	13			LRC_SQ_VCCRX1	13			
AK25	LRC_SQ_HDOUTP1	13		T	LRC_SQ_HDOUTP1	13			T

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AH25	LRC_SQ_VCCOB1	13			LRC_SQ_VCCOB1	13			
AJ25	LRC_SQ_HDOUTN1	13		C	LRC_SQ_HDOUTN1	13		C	
AH26	LRC_SQ_VCCTX1	13			LRC_SQ_VCCTX1	13			
AJ26	LRC_SQ_HDOUTN0	13		C	LRC_SQ_HDOUTN0	13		C	
AK27	LRC_SQ_VCCOB0	13			LRC_SQ_VCCOB0	13			
AK26	LRC_SQ_HDOUTP0	13		T	LRC_SQ_HDOUTP0	13		T	
AH27	LRC_SQ_VCCTX0	13			LRC_SQ_VCCTX0	13			
AJ29	LRC_SQ_HDINN0	13		C	LRC_SQ_HDINN0	13		C	
AJ30	LRC_SQ_VCCIB0	13			LRC_SQ_VCCIB0	13			
AK29	LRC_SQ_HDINP0	13		T	LRC_SQ_HDINP0	13		T	
AH30	LRC_SQ_VCCRX0	13			LRC_SQ_VCCRX0	13			
AG27	CFG2	8			CFG2	8			
AD25	CFG1	8			CFG1	8			
AG28	CFG0	8			CFG0	8			
AG30	PROGRAMN	8			PROGRAMN	8			
AG29	CCLK	8			CCLK	8			
AC24	INITN	8			INITN	8			
AF27	DONE	8			DONE	8			
GNDIO	GNDIO8	-			GNDIO8	-			
AF28	WRITEN***	8			WRITEN***	8			
AE26	CS1N***	8			CS1N***	8			
AB23	CSN***	8			CSN***	8			
AF29	D0/SPIFASTN***	8			D0/SPIFASTN***	8			
VCCIO	VCCIO8	8			VCCIO8	8			
AF30	D1***	8			D1***	8			
AD26	D2***	8			D2***	8			
AE29	D3***	8			D3***	8			
GNDIO	GNDIO8	-			GNDIO8	-			
AE30	D4***	8			D4***	8			
AD29	D5***	8			D5***	8			
AC25	D6***	8			D6***	8			
AD30	D7/SPID0***	8			D7/SPID0***	8			
VCCIO	VCCIO8	8			VCCIO8	8			
AA22	DI/CSSPI0N***	8			DI/CSSPI0N***	8			
AC26	DOUT/CSON/CSSPI1N***	8			DOUT/CSON/CSSPI1N***	8			
AA23	BUSY/SISPI***	8			BUSY/SISPI***	8			
AB22	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
AC27	PR65B	3	RLM0_GDLLC_FB_A	C	PR85B	3	RLM0_GDLLC_FB_A/RDQ82	C	
GNDIO	GNDIO3	-			GNDIO3	-			
AC28	PR65A	3	RLM0_GDLLT_FB_A	T	PR85A	3	RLM0_GDLLT_FB_A/RDQ82	T	
AC29	PR64B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR84B	3	RLM0_GDLLC_IN_A**/RDQ82	C (LVDS)*	
AC30	PR64A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR84A	3	RLM0_GDLLT_IN_A**/RDQ82	T (LVDS)*	
AB30	PR63B	3	RLM0_GPLLC_IN_A**	C	PR83B	3	RLM0_GPLLC_IN_A**/RDQ82	C	
VCCIO	VCCIO3	3			VCCIO3	3			
AA30	PR63A	3	RLM0_GPLLT_IN_A**	T	PR83A	3	RLM0_GPLLT_IN_A**/RDQ82	T	
AB29	PR62B	3	RLM0_GPLLC_FB_A	C (LVDS)*	PR82B	3	RLM0_GPLLC_FB_A/RDQ82	C (LVDS)*	
AB28	PR62A	3	RLM0_GPLLT_FB_A	T (LVDS)*	PR82A	3	RLM0_GPLLT_FB_A/RDQS82	T (LVDS)*	
GNDIO	GNDIO3	-			GNDIO3	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
Y15	GND	-			GND	-		
Y16	GND	-			GND	-		
Y17	GND	-			GND	-		
AA26	NC	-			NC	-		
AB10	PL73B	6	LDQ71	C (LVDS)*	NC	-		
AB11	NC	-			NC	-		
AB12	NC	-			NC	-		
AB13	NC	-			NC	-		
AB14	NC	-			NC	-		
AB15	NC	-			NC	-		
AB16	NC	-			NC	-		
AB17	NC	-			NC	-		
AB19	NC	-			NC	-		
AB20	NC	-			NC	-		
AB21	NC	-			NC	-		
AB9	PL73A	6	LDQ71	T (LVDS)*	NC	-		
AC10	PL74B	6	LDQ71	C	NC	-		
AC11	NC	-			NC	-		
AC21	NC	-			NC	-		
AC22	NC	-			NC	-		
AC8	PL70B	6	LDQ71	C	NC	-		
AC9	PL74A	6	LDQ71	T	NC	-		
AD21	NC	-			NC	-		
AD22	NC	-			NC	-		
AD4	PL68A	6	LDQ71	T	NC	-		
AD5	PL68B	6	LDQ71	C	NC	-		
AD6	PL71A	6	LDQS71	T (LVDS)*	NC	-		
AD7	PL72A	6	LDQ71	T	NC	-		
AD8	PL72B	6	LDQ71	C	NC	-		
AE23	NC	-			NC	-		
AE5	PL69A	6	LDQ71	T (LVDS)*	NC	-		
AE6	PL70A	6	LDQ71	T	NC	-		
AE7	PL71B	6	LDQ71	C (LVDS)*	NC	-		
AF20	NC	-			NC	-		
AF23	NC	-			NC	-		
AF5	PL69B	6	LDQ71	C (LVDS)*	NC	-		
AG23	NC	-			NC	-		
AG26	NC	-			NC	-		
D10	PT10A	0		T	NC	-		
E10	PT9B	0		C	NC	-		
E11	PT10B	0		C	NC	-		
F10	PT9A	0		T	NC	-		
F20	NC	-			NC	-		
F23	NC	-			NC	-		
F8	PL6B	7	LDQ6	C (LVDS)*	NC	-		
G10	NC	-			NC	-		
G20	NC	-			NC	-		
G21	NC	-			NC	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AA1	PL81A	6	LDQS81	T (LVDS)*
GNDIO	GNDIO6	-		
AA2	PL81B	6	LDQ81	C (LVDS)*
Y3	PL82A	6	LDQ81	T
AB1	PL82B	6	LDQ81	C
VCCIO	VCCIO6	6		
Y9	PL83A	6	LDQ81	T (LVDS)*
Y8	PL83B	6	LDQ81	C (LVDS)*
Y7	PL84A	6	LDQ81	T
AA7	PL84B	6	LDQ81	C
GNDIO	GNDIO6	-		
VCCIO	VCCIO6	6		
AB2	PL95A	6	LDQ99	T (LVDS)*
AB3	PL95B	6	LDQ99	C (LVDS)*
AA5	PL96A	6	LDQ99	T
AA6	PL96B	6	LDQ99	C
AB4	PL97A	6	LDQ99	T (LVDS)*
VCCIO	VCCIO6	6		
AB5	PL97B	6	LDQ99	C (LVDS)*
AA8	PL98A	6	LDQ99	T
AA9	PL98B	6	LDQ99	C
AC1	PL99A	6	LLM0_GPLL_IN_A**/LDQS99	T (LVDS)*
GNDIO	GNDIO6	-		
AC2	PL99B	6	LLM0_GPLLC_IN_A**/LDQ99	C (LVDS)*
AC4	PL100A	6	LLM0_GPLLFB_A/ LDQ99	T
AC3	PL100B	6	LLM0_GPLLC_FB_A/ LDQ99	C
VCCIO	VCCIO6	6		
AC7	PL101A	6	LLM0_GDLLT_IN_A**/LDQ99	T (LVDS)*
AC6	PL101B	6	LLM0_GDLLC_IN_A**/LDQ99	C (LVDS)*
AC5	PL102A	6	LLM0_GDLLT_FB_A/ LDQ99	T
AD3	PL102B	6	LLM0_GDLLC_FB_A/ LDQ99	C
GNDIO	GNDIO6	-		
AB8	LLM0_PLLCAP	6		
AD2	PL104A	6		T
AD1	PL104B	6		C
AE2	TCK	-		
AE1	TDI	-		
AF2	TMS	-		
AF1	TDO	-		
AG1	VCCJ	-		
AH1	LLC_SQ_VCCRX3	14		
AK2	LLC_SQ_HDINP3	14		T
AJ1	LLC_SQ_VCCIB3	14		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F21	GND	-			GND	-		
G31	GND	-			GND	-		
G4	GND	-			GND	-		
J12	GND	-			GND	-		
J16	GND	-			GND	-		
J19	GND	-			GND	-		
J23	GND	-			GND	-		
K27	GND	-			GND	-		
K31	GND	-			GND	-		
K4	GND	-			GND	-		
K8	GND	-			GND	-		
M16	GND	-			GND	-		
M17	GND	-			GND	-		
M18	GND	-			GND	-		
M19	GND	-			GND	-		
N16	GND	-			GND	-		
N17	GND	-			GND	-		
N18	GND	-			GND	-		
N19	GND	-			GND	-		
N26	GND	-			GND	-		
N31	GND	-			GND	-		
N4	GND	-			GND	-		
N9	GND	-			GND	-		
R16	GND	-			GND	-		
R17	GND	-			GND	-		
R18	GND	-			GND	-		
R19	GND	-			GND	-		
T12	GND	-			GND	-		
T13	GND	-			GND	-		
T15	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T18	GND	-			GND	-		
T19	GND	-			GND	-		
T20	GND	-			GND	-		
T22	GND	-			GND	-		
T23	GND	-			GND	-		
T26	GND	-			GND	-		
T31	GND	-			GND	-		
T4	GND	-			GND	-		
T9	GND	-			GND	-		
U12	GND	-			GND	-		
U13	GND	-			GND	-		
U15	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
U18	GND	-			GND	-		
U19	GND	-			GND	-		
U20	GND	-			GND	-		



LatticeECP2/M Family Data Sheet

Revision History

September 2013

Data Sheet DS1006

Date	Version	Section	Change Summary
February 2006	01.0	—	Initial release.
August 2006	01.1	Introduction	Updated Table 1-1 "LatticeECP2 Family Selection Guide".
		Architecture	Updated Figure 2-2 "PFU Diagram". Updated Figure 2-13 "Secondary Clock Regions ECP2-50". Updated Figure 2-25 "PIC Diagram". Updated Figure 2-26 "Input Register Block for Left, Right and Bottom Edges". Updated Figure 2-28 "Output Register Block for Left, Right and Bottom Edges". Updated Figure 2-30 "DQS Input Routing for Left and Right Edges". Updated Figure 2-32 "Edge Clock, DLL Calibration and DQS Local Bus Distribution". Table 2-15 Selectable Master Clock (CCLK) Frequencies - Removed frequencies 15, 20, 21, 22, 23, 30, 34, 41, 45, 51, 55, 60. Replaced "CLKINDEL" with "CLKO". Updated SED section. Qualified device migration capability when using DQS banks for DDR interfaces.
		DC and Switching Characteristics	Added VCCPLL to the Recommended Operating Conditions table. Removed note 5 from "Hot Specifications" section. Added notes 7 and 8 to "Initialization Supply" Current table. Change note 6 - "...down to 95MHz" to "...down to 95MHz for DDR and 133MHz for DDR2". New "Typical Building Block Function Performance" numbers. New External Switching Characteristics numbers. New Internal Switching Characteristics numbers. New Family Timing Adders numbers. Updated Timings for GPLPs, SPLPs and DLLs. Added sysCONFIG waveforms. Remove HSTL15D_II from sysIO Recommended Operating Conditions table. Updated Supply and Initialization Currents for ECP2-50.
		Pinout Information	Added VCCPLL to the Signal Descriptions table. Updated Logic Signal Connections tables to include 484-fpBGA for the ECP2-50. Added Logic Signal Connections tables for ECP2-12 devices. Updated Pin Information Summary table to include ECP2-12. Updated Power Supply and NC Connections table to include ECP2-12. Added note 2 to DDR Strobe (DQS) Pin table. Added Information on: PCI, DDR & SPI4.2 Capabilities of the device-Package combination.

© 2013 Lattice Semiconductor Corp. All Lattice trademarks, registered trademarks, patents, and disclaimers are as listed at www.latticesemi.com/legal. All other brand or product names are trademarks or registered trademarks of their respective holders. The specifications and information herein are subject to change without notice.